FAIRCHILD SEMICONDUCTOR®

QFET®

FQP18N50V2/FQPF18N50V2
500V N-Channel MOSFET

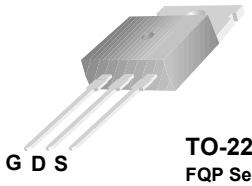
Features

- 550V @T_J = 150°C
- Typ. $R_{DS(on)}$ = 0.265Ω @V_{GS} = 10 V
- Low gate charge (typical 42 nC)
- Low Crss (typical 11 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

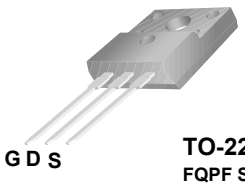
Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

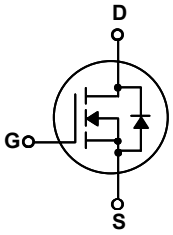
This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switched mode power supplies, active power factor correction, electronic lamp ballast based on half bridge topology.



TO-220
FQP Series



TO-220F
FQPF Series



Absolute Maximum Ratings

Symbol	Parameter		FQP18N50V2	FQPF18N50V2	Units
V_{DSS}	Drain-Source Voltage		500		V
I_D	Drain Current	- Continuous (T_C = 25°C)	18	18*	A
		- Continuous (T_C = 100°C)	12.1	12.1*	A
I_{DM}	Drain Current	- Pulsed (Note 1)	72	72*	A
V_{GSS}	Gate-Source Voltage		± 30		V
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	330		mJ
I_{AR}	Avalanche Current	(Note 1)	18		A
E_{AR}	Repetitive Avalanche Energy	(Note 1)	25		mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5		V/ns
P_D	Power Dissipation (T_C = 25°C)		208	69	W
	- Derate above 25°C		1.67	0.55	W/°C
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +150		°C
T_L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300		°C

Thermal Characteristics

Symbol	Parameter	FQP18N50V2	FQPF18N50V2	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.6	1.8	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink	0.5	--	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	62.5	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
PV218N50	FQP18N50V2	TO-220	-	-	50
PFV218N50	FQPF18N50V2	TO-220F	-	-	50

Electrical Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I_D = 250 μA	500	--	--	V
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temperature Coefficient	I_D = 250 μA, Referenced to 25°C	--	0.5	--	V/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 500 V, V_{GS} = 0 V	--	--	1	μA
		V_{DS} = 400 V, T_C = 125°C	--	--	10	μA
I_{GSSF}	Gate-Body Leakage Current, Forward	V_{GS} = 30 V, V_{DS} = 0 V	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = -30 V, V_{DS} = 0 V	--	--	-100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250 μA	3.0	--	5.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	V_{GS} = 10 V, I_D = 9 A	--	0.225	0.265	Ω
g_{FS}	Forward Transconductance	V_{DS} = 40 V, I_D = 9 A (Note 4)	--	16	--	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V, f = 1.0 MHz	--	2530	3290	pF
C_{oss}	Output Capacitance		--	300	390	pF
C_{rss}	Reverse Transfer Capacitance		--	11	14.3	pF
C_{oss}	Output Capacitance	V_{DS} = 400 V, V_{GS} = 0 V, f = 1.0 MHz	--	76	--	pF
C_{oss} eff.	Effective Output Capacitance	V_{DS} = 0V to 400 V, V_{GS} = 0 V	--	150	--	pF
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 250 V, I_D = 18 A, R_G = 25 Ω	--	40	90	ns
t_r	Turn-On Rise Time		--	150	310	ns
$t_{d(off)}$	Turn-Off Delay Time		--	95	200	ns
t_f	Turn-Off Fall Time	(Note 4, 5)	--	110	230	ns
Q_g	Total Gate Charge	V_{DS} = 400 V, I_D = 18 A, V_{GS} = 10 V	--	42	55	nC
Q_{gs}	Gate-Source Charge		--	12	--	nC
Q_{gd}	Gate-Drain Charge	(Note 4, 5)	--	14	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I_S	Maximum Continuous Drain-Source Diode Forward Current		--	--	18	A
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current		--	--	72	A
V_{SD}	Drain-Source Diode Forward Voltage	V_{GS} = 0 V, I_S = 18 A	--	--	1.4	V
t_{rr}	Reverse Recovery Time	V_{GS} = 0 V, I_S = 18 A, dI_F / dt = 100 A/μs (Note 4)	--	420	--	ns
Q_{rr}	Reverse Recovery Charge		--	5.4	--	μC

Notes:

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. L = 1.83mH, I_{AS} = 18A, V_{DD} = 50V, R_G = 25 Ω, Starting T_J = 25°C
3. I_{SD} ≤ 18A, di/dt ≤ 200A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C
4. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2%
5. Essentially independent of operating temperature

Typical Performance Characteristics

Figure 1. On-Region Characteristics

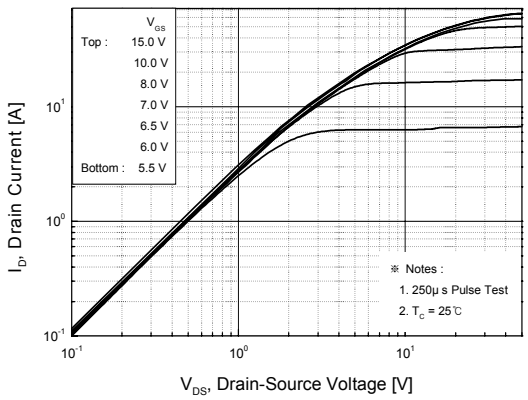


Figure 2. Transfer Characteristics

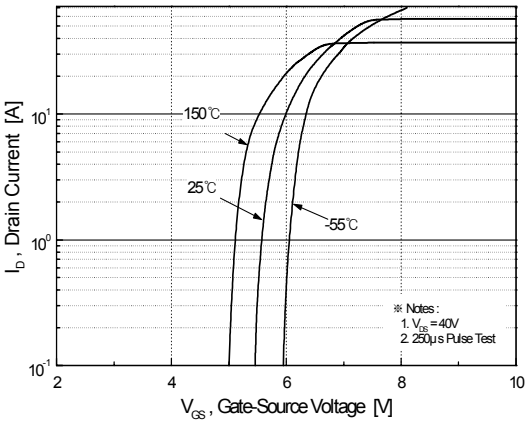


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

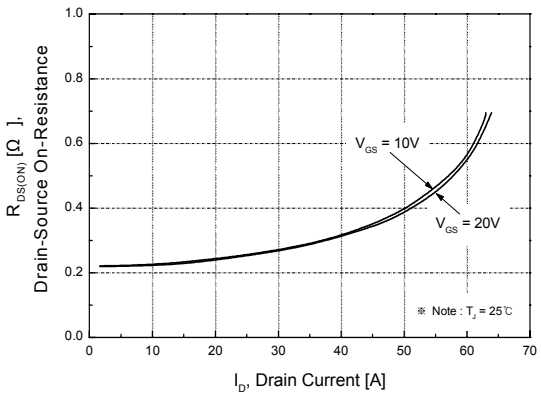


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperatue

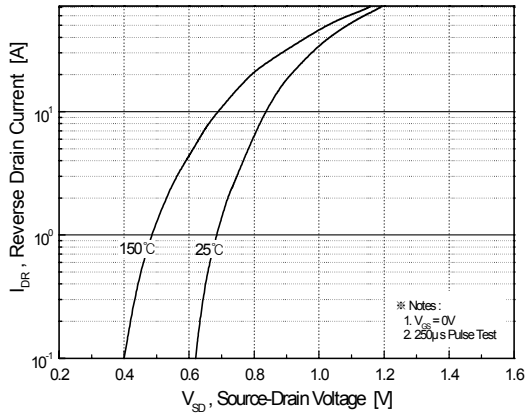


Figure 5. Capacitance Characteristics

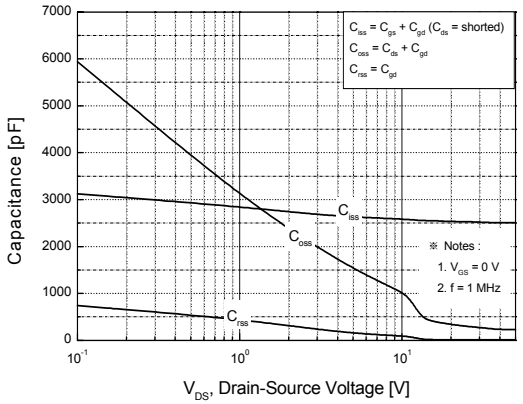
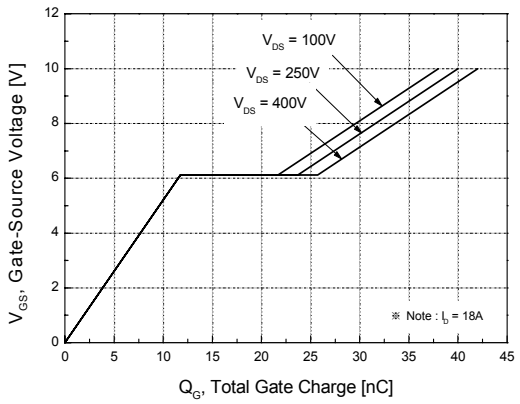


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

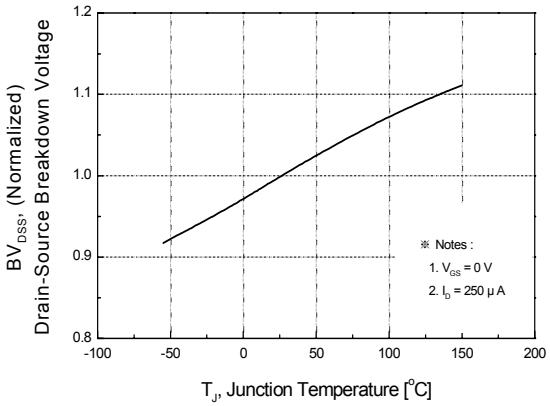


Figure 8. On-Resistance Variation vs. Temperature

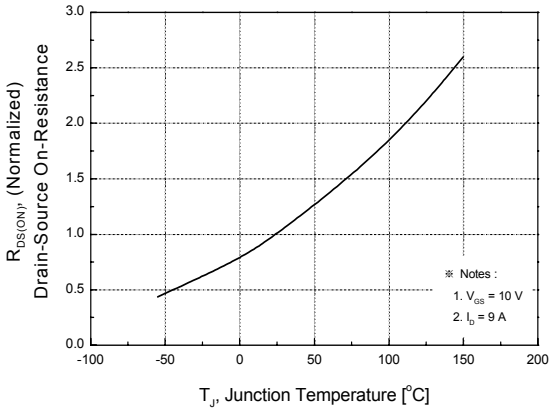


Figure 9-1. Maximum Safe Operating Area for FQP18N50V2

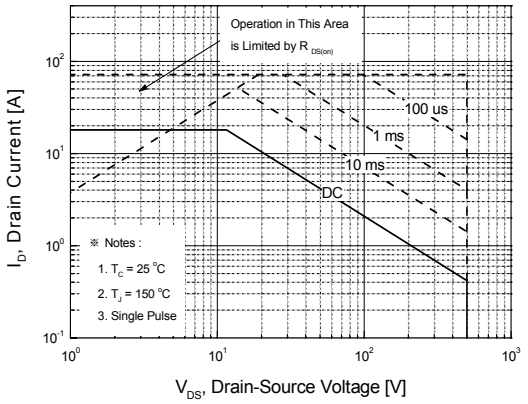


Figure 9-2. Maximum Safe Operating Area for FQPF18N50V2

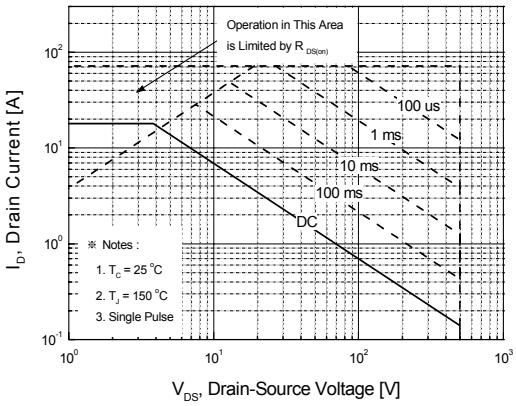
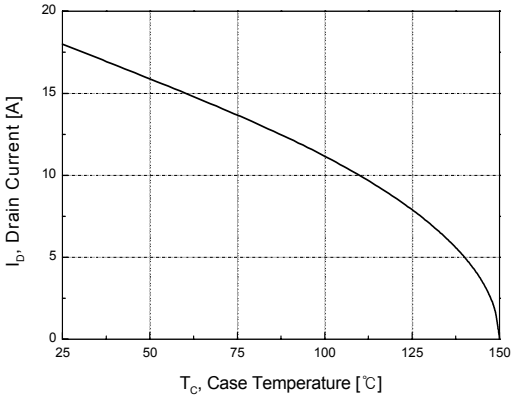


Figure 10. Maximum Drain Current vs. Case Temperature



Typical Performance Characteristics (Continued)

Figure 11-1. ransient Thermal Response Curve for FQP18N50V2

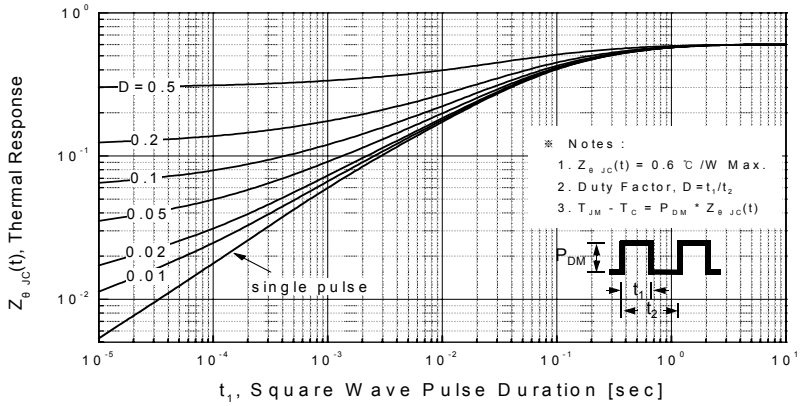
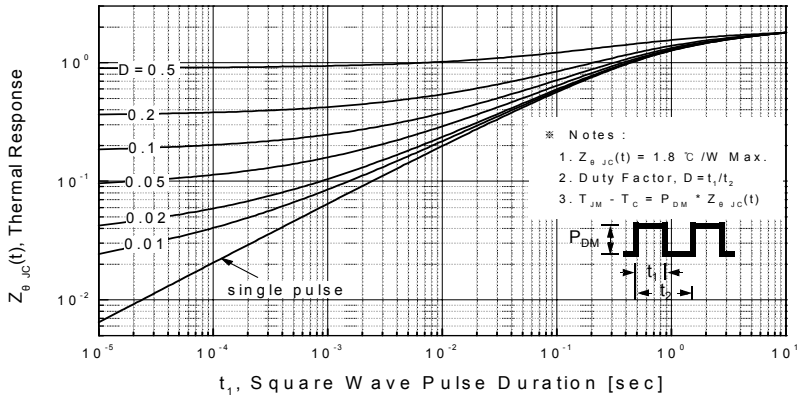
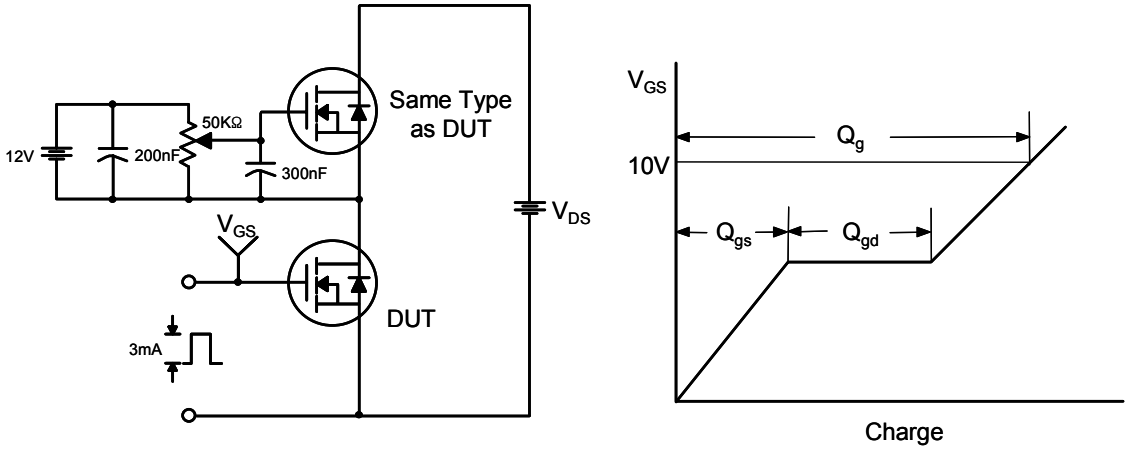


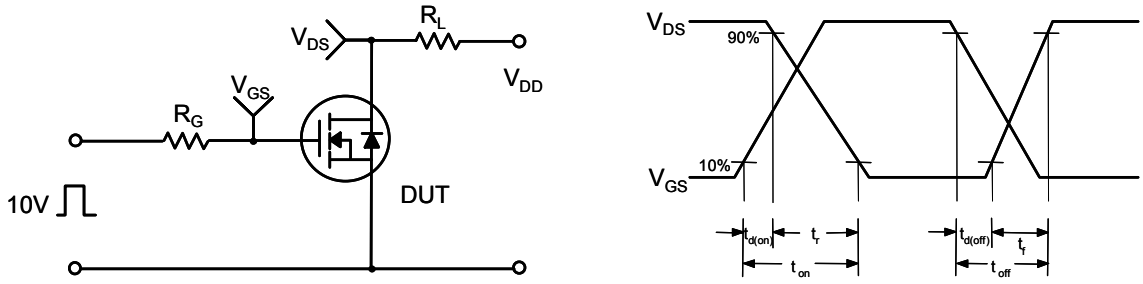
Figure 11-2. Transient Thermal Response Curve for FQPF18N50V2



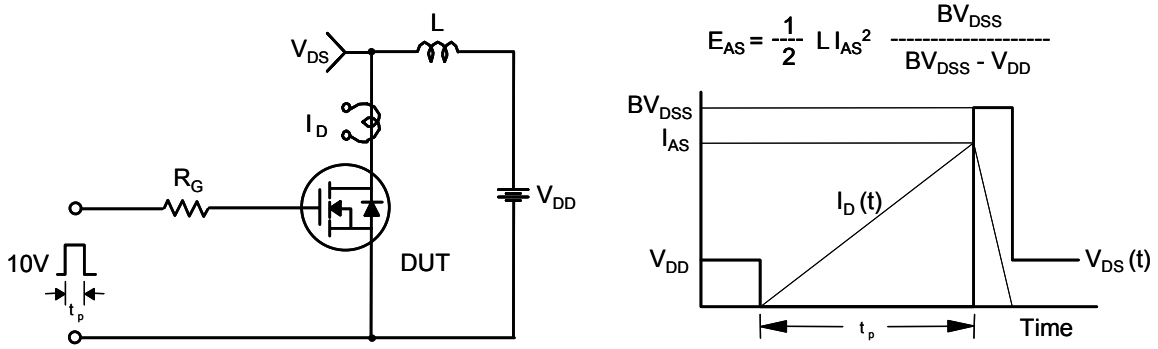
Gate Charge Test Circuit & Waveform



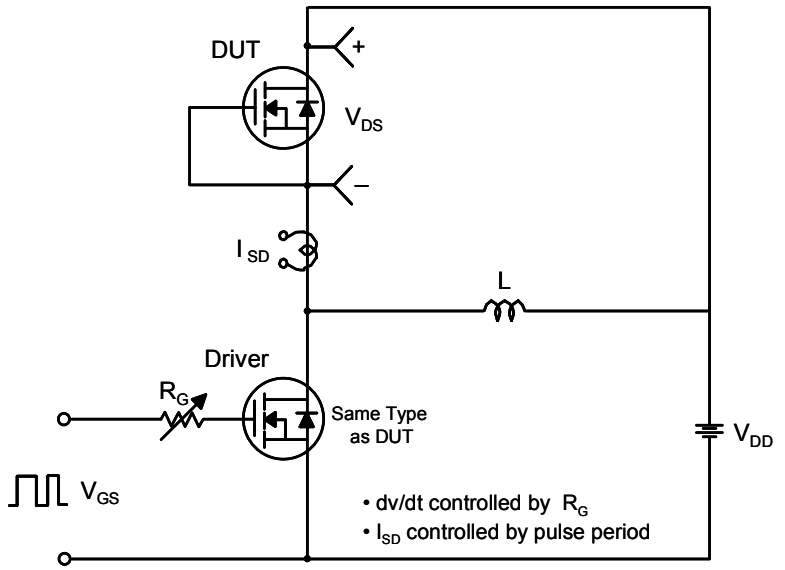
Resistive Switching Test Circuit & Waveforms

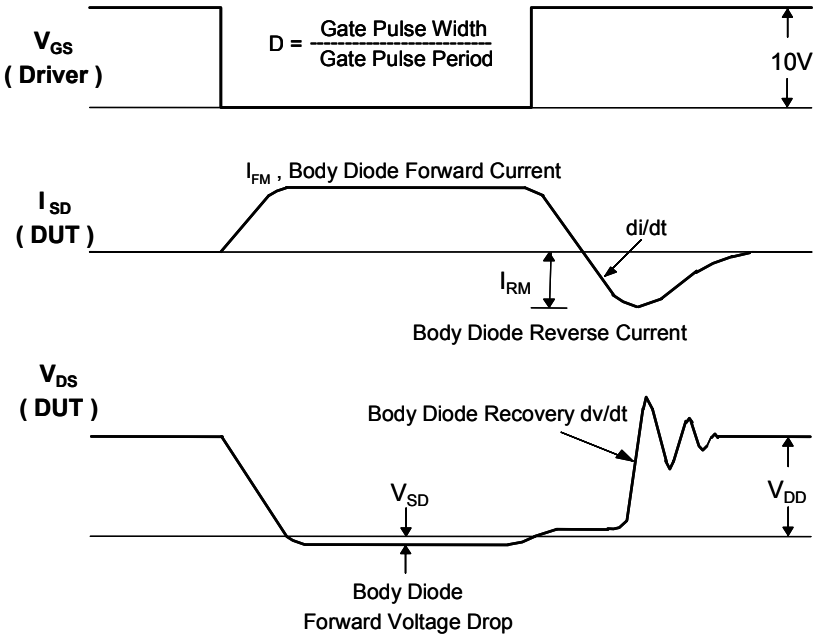


Unclamped Inductive Switching Test Circuit & Waveforms



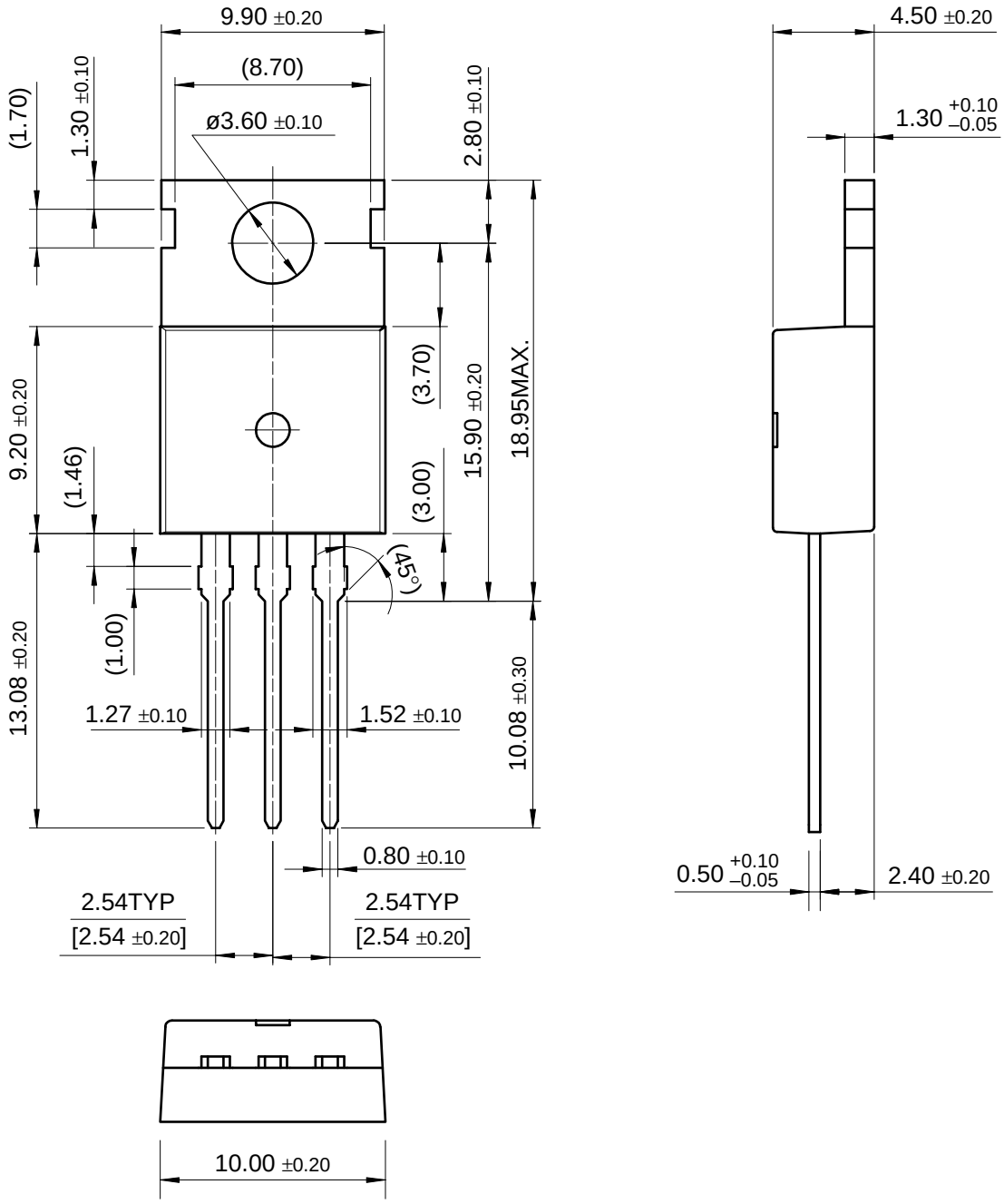
Peak Diode Recovery dv/dt Test Circuit & Waveforms





Mechanical Dimensions

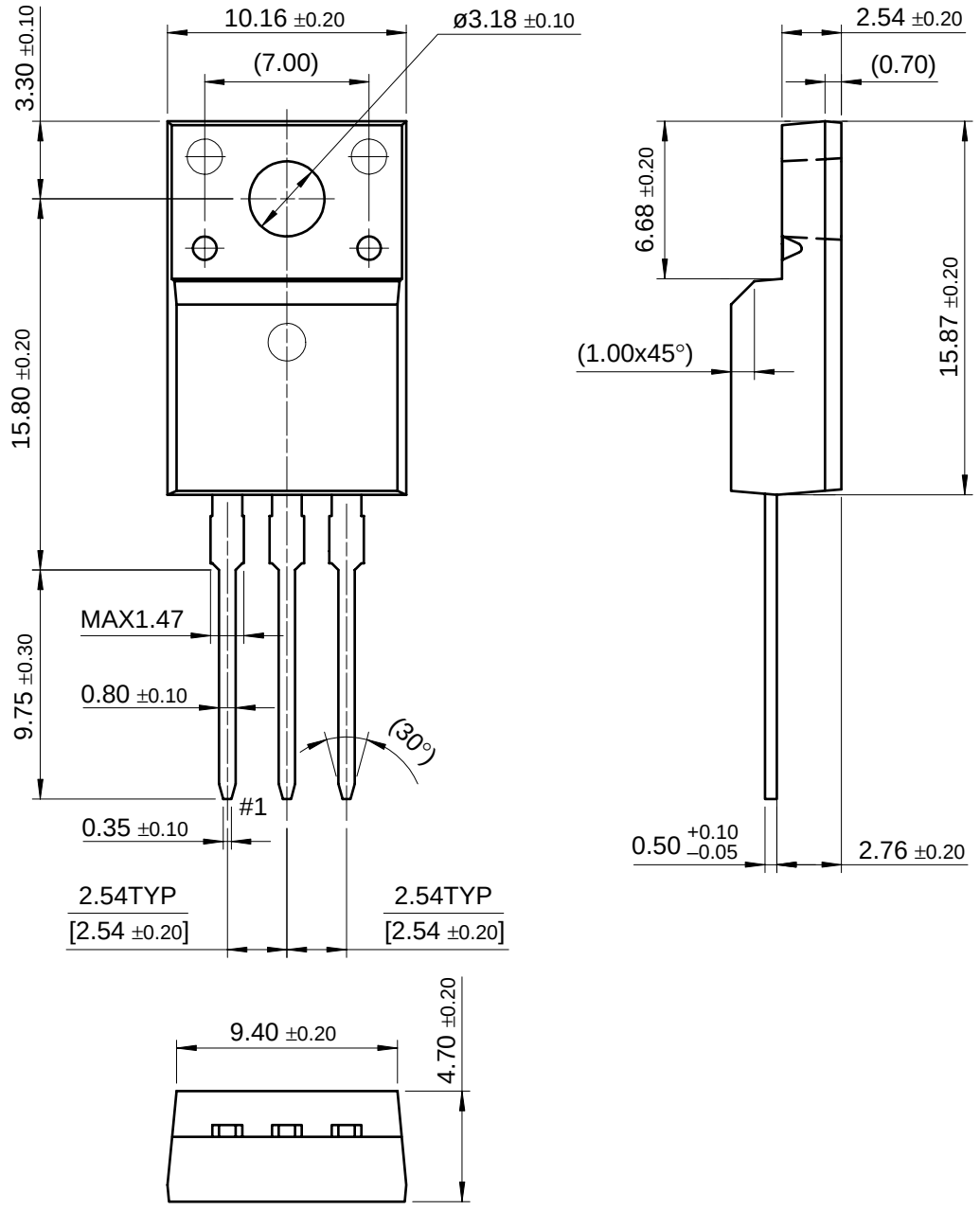
TO-220



Dimensions in Millimeters

Mechanical Dimensions (Continued)

TO-220F



Dimensions in Millimeters

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

Rev. I15

FQPF18N50V2

500V N-Channel Advanced QFET V2 series

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- Design center

General description

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- Low Crss (typical 11 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

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Product status/pricing/packaging

BUY

Product	Product status	Pb-free Status	Package type	Leads	Packing method	Package Marking Convention**
FQPF18N50V2	Lifetime Buy		TO-220F	3	RAIL	Line 1: **$Y** (Fairchild logo) &**Z** (Asm. Plant Code) &**4** (4-Digit Date Code) Line 2: FQPF Line 3: 18N50V2
FQPF18N50V2SDTU	Lifetime Buy		TO-220F	3	RAIL	Line 1: **$Y** (Fairchild logo) &**Z** (Asm. Plant Code) &**4** (4-Digit Date Code)

Indicates product with Pb-free second-level interconnect. For more information click here.

Package marking information for product FQPF18N50V2 is available. Click here for more information .

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Models

Package & leads	Condition	Temperature range	Vcc range	Software version	Revision date
PSPICE					
TO-220F-3	Electrical/Thermal	-55°C to 150°C	0.1V to 50V	9.2	Feb 4, 2003

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Qualification Support

Click on a product for detailed qualification data

Product
FQPF18N50V2
FQPF18N50V2SDTU

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